

Data sheet acquired from Harris Semiconductor SCHS033C - Revised October 2003

BCD-to-Decimal Decoder

High-Voltage Types (20-Volt Rating)

CD4028B types are BCD-todecimal or binary-to-octal decoders consisting of buffering on all 4 inputs, decodinglogic gates, and 10 output buffers. A BCD code applied to the four inputs, A to D, results in a high level at the selected one of 10 decimal decoded outputs. Similarly, a 3-bit binary code applied to inputs A through C is decoded in octal code at output 0 to 7 if D = "0". High drive capability is provided at all outputs to enhance dc and dynamic performance in high fan-out applications.

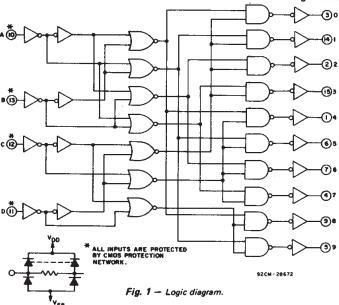
The CD4028B-Series types are supplied in 16-lead hermetic dual-in-line ceramic packages (F3A suffix), 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (M, M96, MT, and NSR suffixes), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).

Features:

- BCD-to-decimal decoding or binary-to-octal decoding
- High decoded output drive capability
- "Positive logic" inputs and outputs. decoded outputs go high on selection
- Medium-speed operation. . . .
 - tpHL, tpLH = 80 ns (typ.) @ VDD = 10 V
- Standardized, symmetrical output characteristics
- 100% tested for quiescent current at 20 V
- Maximum input current of 1 μA at 18 V over full package-temperature range; 100 nA at 18 V and 25°C
- Noise margin (over full packagetemperature range):
 - 1 V at V_{DD} = 5 V
 - 2 V at V_{DD} = 10 V
- 2.5 V at V_{DD} = 15 V = 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"

Applications:

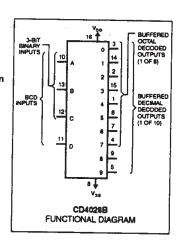
- Code conversion ■ Indicator-tube decoder
- Address decoding—memory selection control



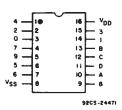
MAXIMUM RATINGS, Absolute-Maximum Values:

LEAD TEMPERATURE (DURING SOLDERING):

| DC SUPPLY-VOLTAGE RANGE, (VDD) | |
|---|-------------------------------|
| Voltages referenced to VSS Terminal) | 0.5V to +20V |
| INPUT VOLTAGE RANGE, ALL INPUTS | 0.5V to V _{DD} +0.5V |
| DC INPUT CURRENT, ANY ONE INPUT | ±10mA |
| POWER DISSIPATION PER PACKAGE (PD): | |
| For T _A = -55°C to +100°C | 500mW |
| For TA = +100°C to +125°C | |
| DEVICE DISSIPATION PER OUTPUT TRANSISTOR | · |
| FOR TA = FULL PACKAGE-TEMPERATURE RANGE (All Pa | ckage Types) 100mW |
| OPERATING-TEMPERATURE RANGE (TA) | |
| STORAGE TEMPERATURE RANGE (Teta) | |



CD4028B Types



Top View **TERMINAL DIAGRAM**

TABLE I - TRUTH TABLE

| D | С | В | Α | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0 | 0 | 0 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0 | 0 | 1 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0 | 0 | 1 | 1 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 |
| 0 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 |
| 0 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0 |
| 0 | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 |
| 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 |
| 1 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |
| 1 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 1 | 0 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 1 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 1 | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

I = HIGH LEVEL

0 = LOW LEVEL

CD4028B Types

RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

| CHARACTERISTIC | L | IMITS | UNITS |
|--|------|-------|-------|
| | MIN. | MAX. | |
| Supply Voltage Range | * * | | |
| (For T _A = Full Package Temperature Range) | 3 | 18 | V |

STATIC ELECTRICAL CHARACTERISTICS *

| CHARACTER- | CON | DITIO | vs ["] | LIMI | LIMITS AT INDICATED TEMPERATURES (°C) | | | | | | | | |
|---|----------|-------|-----------------|-------|---------------------------------------|-------|-------|----------|-------|------|-------|--|--|
| ISTIC | Vo | VIN | VDD | | | | | <u> </u> | +25 | | UNITS | | |
| | (v) | (V) | (V) | -55 | -40 | +85 | +125 | Min. | Тур. | Max. | 1 | | |
| Quiescent Device | _ | 0,5 | 5 | 5 | 5 | 150 | 150 | - : | 0.04 | 5 | | | |
| Current, | - | 0,10 | 10 | 10 | 10 | 300 | 300 | - | .0.04 | - 10 | 1. | | |
| IDD Max. | - | 0,15 | 15 | 20 | 20 | 600 | 600 | - : | 0.04 | 20 | μΑ | | |
| | - | 0,20 | 20 | 100 | 100 | 3000 | 3000 | - | 0,08 | 100 | 1 | | |
| Output Low | 0.4 | 0,5 | 5 | 0.64 | 0.61 | 0.42 | 0,36 | 0.51 | 1 | - | | | |
| (Sink) Current | 0,5 | 0,10 | 10 | 1.6 | 1.5 | 1,1 | 0.9 | 1.3 | 2.6 | | 1 | | |
| IOL Min. | 1,5 | 0,15 | 15 | 4.2 | 4 | 2.8 | 2.4 | 34 | 6.8 | - | 1 | | |
| Output High | 4.6 | 0,5 | 5 | -0.64 | -0,61 | -0.42 | -0.36 | -0.51 | 1 | - | mA | | |
| (Source) Current, IOH Min. | 2.5 | 0,5 | • 5 | -2 | -1.8 | -1.3 | -1.15 | -1.6 | -3.2 | - | 1 | | |
| | 9.5 | 0,10 | 10 | -1.6 | -1,5 | -1.1 | -0.9 | -1.3 | -2.6 | - | 1 | | |
| | 13.5 | 0,15 | 15 | -4.2 | -4 | -2.8 | -2.4 | -3.4 | - 6.8 | - | 1 | | |
| Output Voltage: | - | 0,5 | 5 | | 0 | .05 | | _ | 0 | 0.05 | | | |
| Low-Level, VOL Max. | _ | 0,10 | 10 | | 0 | ,05 | | - | 0 | 0.05 | | | |
| *OL 1418X. | - | 0,15 | 15 | | 0. | .05 | | - | 0 | 0.05 | l v l | | |
| Output Voltage: | - | 0,5 | 5 | | 4. | .95 | | 4.95 | 5 | - | * | | |
| High Level | _ | 0,10 | 10 | | 9. | 95 | | 9,95 | 10 | - | | | |
| VOH Min. | _ | 0,15 | 15 | | 14 | .95 | | 14.95 | 15 | - | | | |
| Input Low | 0.5, 4.5 | | 5 | | 1 | .5 | | _ | - | 1.5 | | | |
| Voltage, Vil Max. | 1, 9 | | 10 | | | 3 | | _ | _ | 3 | | | |
| VIL MAX. | 1.5,13.5 | | 15 | | | 4 | | - | - | 4 | | | |
| Input High Voltage, VIH Min. Input Current IJN Max. | 0.5, 4,5 | | 5 | | 3 | .5 | | 3,5 | - | _ | V | | |
| | 1, 9 | | 10 | | | 7 | | 7 | _ |] | | | |
| | 1.5,13,5 | _ | 15 | | 1 | 1 | | 7.1 | _ | _ | | | |
| | - | 0,18 | 18 | ±0,1 | ±0.1 | ±1 | ±1 | - | ±10−5 | ±0.1 | μΑ | | |

DYNAMIC ELECTRICAL CHARACTERISTICS at T $_A$ = 25°C, C $_L$ = 50 pF, Input t_r,t_f = 20 ns, R $_L$ = 200 k Ω

| CHARACTERISTIC | TEST CONDITIONS | LIM | | |
|------------------------------------|---------------------|------|------|-------|
| CHARACIERISTIC | V _{DD} (V) | Тур. | Max. | UNITS |
| Propagation Delay Time: | 5 | 175 | 350 | ns |
| tPHL, tPLH | 10 | 80 | 160 | ١. |
| | 15 | 60 | 120 | |
| | 5 | 100 | 200 | |
| Transition Time | 10 | 50 | 100 | ns |
| tTHL, tTLH | 15 | 40 | 80 | i |
| Input Capacitance, C _{IN} | _ | 5 | 7.5 | pF |

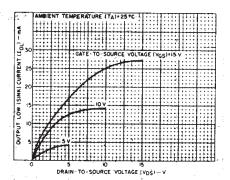


Fig. 2 — Typical output low (sink) current characteristics.

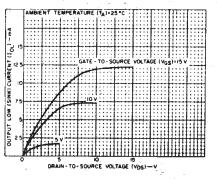


Fig. 3 — Minimum output fow (sink) current characteristics.

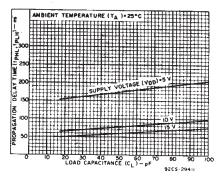


Fig. 4 — Typical propagation delay time as a function of load capacitance.

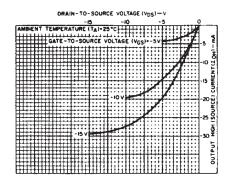


Fig. 5 — Typical output high (source) current characteristics.

TABLE II - CODE CONVERSION CHART

| Γ | | | | | INPU | TO | ODES | ; | | Γ | | | | | | | | | | | _ | | | | |
|----|----|----|----|---------------|----------|----------|------------------|-------|---------|---|---|---|---|---|----|----|----|---|----|-----|----|----|----|----|----|
| | | | | Hexa Decid | 1 | Di | ecima |) | | | | | | | | | | | | | | | | | |
| IN | (P | UT | S | IT IARY | IΤ ΑΥ | EXCESS-3 | EXCESS-3 GRAY | AIKEN | 4-2-2-1 | | | | | 1 | ou | TP | UT | N | UM | 8 E | R | | | | |
| D | С | В | Α | 4-8 BIN | 40 86 | Ä | S.R. | ₹ | 4.2 | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 |
| 0 | 0 | 0 | 0 | 0 | 0 | | | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0 | 0 | 0 | 1 | 1 | 1 | | | 1 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0 | 0 | 1 | 0 | 2 | 3 | | 0 | 2 | 2 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0 | 0 | 1 | 1 | 3 | 2 | 0 | 3 | 3 | | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | O- |
| 0 | 1 | 0 | 0 | 4 | 7 | 1 | 4 | 4 | Ц | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0 | 1 | 0 | _1 | 5 | 6 | 2 | | Ц | 3 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0 | 1 | 1 | 0 | 6 | 4 | 3 | 1 | Щ | 4 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0 | 1 | 1 | 1 | 7 | 5 | 4 | 2 | Ц | Ц | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 1 | 0 | 0 | 0 | 8 | 15 | 5 | | Ш | Ц | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| - | 0 | 0 | 1 | 9 | 14 | 6 | | | 5 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 |
| ÷. | 0 | 1 | 0 | 10 | 12 | 7 | 9 | | 6 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 |
| 1 | 0 | 1 | 1 | 11 | 13 | 8 | | 5 | Ц | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 |
| 1 | 1 | 0 | 0 | 12 | 8 | 9 | 5 | 6 | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0 |
| 1_ | 1 | 0 | 1 | 13 | 9 | | 6 | 7 | 7 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 |
| 1 | 1 | 1 | 0 | 14 | 11 | | 8 | 8 | 8 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 |
| 1_ | 1 | 1 | 1 | 15 | 10 | | 7 | 9 | 9 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |

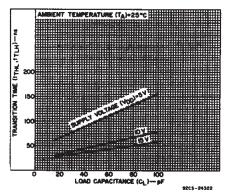


Fig. 8 — Typical transition time as a function of load capacitance.

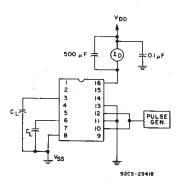


Fig. 10 — Dynamic power dissipation test circuit.

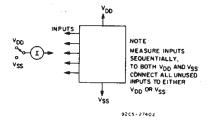


Fig. 9 - Input current test circuit.

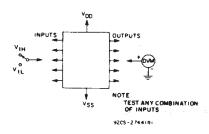


Fig. 11 — Input voltage test circuit.

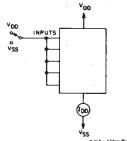


Fig. 12 — Quiescent device current test circuit.

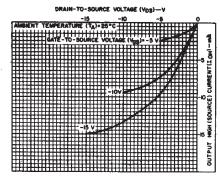


Fig. 6 — Minimum output high (source)

current characteristics.

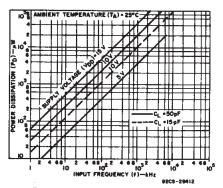


Fig. 7 — Typical dynamic power dissipation as a function of input frequency.

TYPICAL APPLICATIONS

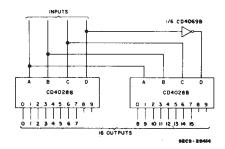
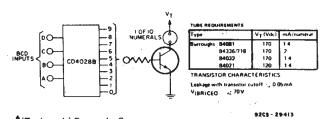


Fig. 13 — Code conversion circuit.

The circuit shown in Fig.13 converts any 4-bit code to a decimal or hexadecimal code. Table 2 shows a number of codes and the decimal or hexadecimal number in these codes which must be applied to the input terminals of the CD4028B to select a particular output. For example: in order to get a high on output No. 8 the input must be either an 8 expressed in 4-Bit Binary code, a 15 expressed in 4-Bit Gray code, or a 5 expressed in Excess-3 code.

CD4028B Types



[♠](Trademark) Burroughs Corp.

Fig. 14 — Neon readout (Nixie Tube $^{f A}$) display application.

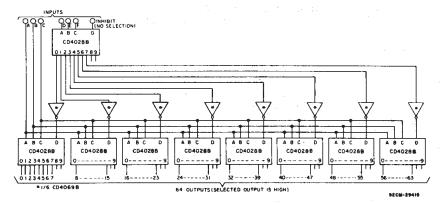
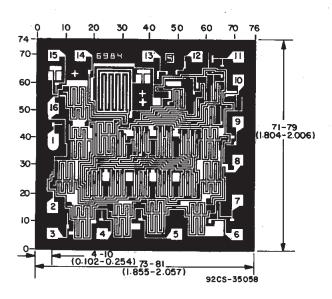


Fig. 15 - 6-bit binary to 1-of-64 address decoder.



CD4028BH DIMENSIONS AND PAD LAYOUT

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10^{-3}) inch).

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PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|--|---|--|--------------------|-----------------------------------|--------------------|------------------------------|
| CD4028BE | ACTIVE | PDIP | N | 16 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| CD4028BEE4 | ACTIVE | PDIP | PDIP N 16 25 Pb-Free CU NIPDAU N (RoHS) | | N / A for Pkg Type | | | |
| CD4028BF | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 SNPB | N / A for Pkg Type |
| CD4028BF3A | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 SNPB | N / A for Pkg Type |
| CD4028BM | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| CD4028BM96 | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| CD4028BM96E4 | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| CD4028BM96G4 | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| CD4028BME4 | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| CD4028BMG4 | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| CD4028BMT | ACTIVE | SOIC | D | 16 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| CD4028BMTE4 | ACTIVE | SOIC | D | 16 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| CD4028BMTG4 | ACTIVE | SOIC | D | 16 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| CD4028BNSR | ACTIVE | SO | NS | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| CD4028BNSRE4 | ACTIVE | SO | NS | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| CD4028BNSRG4 | ACTIVE | SO | NS | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| CD4028BPW | ACTIVE | TSSOP | PW | 16 | 90 | Green (RoHS & CU NIPDAU no Sb/Br) | | Level-1-260C-UNLIM |
| CD4028BPWE4 | ACTIVE | TSSOP | PW | 16 90 Green (RoHS & CU NIPDAU no Sb/Br) | | Level-1-260C-UNLIM | | |
| CD4028BPWG4 | ACTIVE | TSSOP | PW | PW 16 90 Green (RoHS & CU NIPDAU no Sb/Br) | | CU NIPDAU | Level-1-260C-UNLIM | |
| CD4028BPWR | ACTIVE | TSSOP | PW | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| CD4028BPWRE4 | ACTIVE | TSSOP PW 16 2000 Green (RoHS & CU NIPDAU no Sb/Br) | | Level-1-260C-UNLIM | | | | |
| CD4028BPWRG4 | ACTIVE | TSSOP | PW | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |

(1) The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.



PACKAGE OPTION ADDENDUM

9-Oct-2007

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.



TAPE AND REEL INFORMATION





| | Dimension designed to accommodate the component width |
|----|---|
| B0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------|-----------------|--------------------|----|------|--------------------------|--------------------------|---------|---------|---------|------------|-----------|------------------|
| CD4028BM96 | SOIC | D | 16 | 2500 | 330.0 | 16.4 | 6.5 | 10.3 | 2.1 | 8.0 | 16.0 | Q1 |
| CD4028BNSR | SO | NS | 16 | 2000 | 330.0 | 16.4 | 8.2 | 10.5 | 2.5 | 12.0 | 16.0 | Q1 |
| CD4028BPWR | TSSOP | PW | 16 | 2000 | 330.0 | 12.4 | 7.0 | 5.6 | 1.6 | 8.0 | 12.0 | Q1 |





*All dimensions are nominal

| ń | | | | | | | | |
|---|------------|--------------|-----------------|------|------|-------------|------------|-------------|
| | Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
| | CD4028BM96 | SOIC | D | 16 | 2500 | 333.2 | 345.9 | 28.6 |
| | CD4028BNSR | SO | NS | 16 | 2000 | 346.0 | 346.0 | 33.0 |
| | CD4028BPWR | TSSOP | PW | 16 | 2000 | 346.0 | 346.0 | 29.0 |

MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

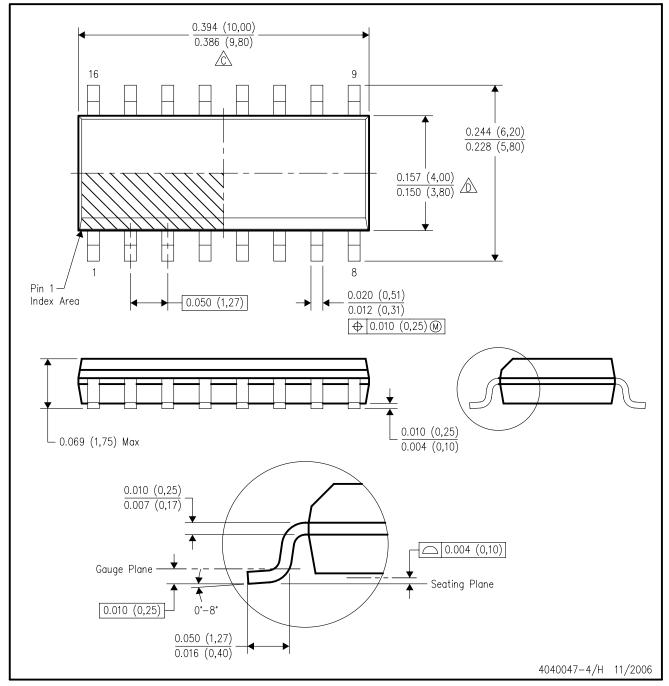
B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AC.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.

